

Electronic Acknowledgement Receipt

EFS ID:	1094697
Application Number:	10651813
Confirmation Number:	9556
Title of Invention:	Semiconductor chip having bond pads and multi-chip package
First Named Inventor:	Young-Hee Song
Customer Number:	20575
Filer:	Alexander Charles Johnson/Li Mei Vermilya
Filer Authorized By:	Alexander Charles Johnson
Attorney Docket Number:	9903-078
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International Application Number:	

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		9903078g.pdf	658879	yes	12

	Multipart Description		
	Doc Desc	Start	End
	Miscellaneous Incoming Letter	1	1
	Amendment - After Non-Final Rejection	2	9
	Applicant Arguments/Remarks Made in an Amendment	10	12
Warnings:			
Information:			
	Total Files Size (in bytes):	658879	

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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.